

**flow PIM 2****1200 V / 100 A****Features**

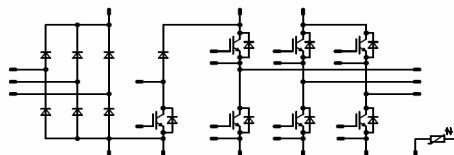
- Three-phase rectifier, BRC, Inverter, NTC
- Very Compact housing, easy to route
- IGBT4 / EmCon4 technology for low saturation losses and improved EMC behavior

**flow 2 17mm housing****Target Applications**

- Motor Drives
- Power Generation

**Types**

- V23990-P760-A-PM
- V23990-P760-AY-PM

**Schematic****Maximum Ratings** $T_j = 25^\circ\text{C}$ , unless otherwise specified

<b>Parameter</b>	<b>Symbol</b>	<b>Condition</b>	<b>Value</b>	<b>Unit</b>
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**Input Rectifier Diode**

Repetitive peak reverse voltage	$V_{RRM}$		1600	V
Forward current	$I_{FAV}$		75	A
Surge (non-repetitive) forward current	$I_{FSM}$		1000	A
$I^2t$ -value	$I^2t$	$t_p = 10 \text{ ms}$	5000	$\text{A}^2\text{s}$
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	156	W
Maximum Junction Temperature	$T_{jmax}$		150	$^\circ\text{C}$

**Inverter Switch**

Collector-emitter breakdown voltage	$V_{CE}$		1200	V
DC collector current	$I_C$		100	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	300	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	272	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15 \text{ V}$	10 800	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$



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datasheet

## Maximum Ratings

 $T_j = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### Inverter Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$	$T_j = T_{jmax}$	85	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	200	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	154	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Brake Switch

Collector-emitter breakdown voltage	$V_{CE}$		1200	V
DC collector current	$I_C$		50	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	150	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	174	W
Gate-emitter peak voltage	$V_{GE}$		±20	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15\text{ V}$	10 800	μs V
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Brake Inverse Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$		10	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	20	A
Brake Inverse Diode	$P_{tot}$	$T_j = T_{jmax}$	52	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Brake Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$		25	A
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	50	A
Power dissipation	$P_{tot}$	$T_j = T_{jmax}$	87	W
Maximum Junction Temperature	$T_{jmax}$		175	°C

### Thermal properties

Storage temperature	$T_{stg}$		-40...+125	°C
Operation temperature under switching condition	$T_{op}$		-40...+ $T_{jmax}$ -25	°C



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**V23990-P760-A-PM****V23990-P760-AY-PM**

datasheet

## Maximum Ratings

$T_J = 25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Isolation Properties</b>				
Isolation voltage	$V_{\text{isol}}$	DC Test Voltage* $t_p = 2 \text{ s}$	4000	V
		AC Voltage $t_p = 1 \text{ min}$	2500	V
Creepage distance				min 12,7 mm
Clearance		with Press-fit pins / with Solder pins	11,58 / 11,82	mm
Comparative Tracking Index	CTI		>200	

\* 100 % tested in production



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## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
		$V_{GE}$ [V]	$V_r$ [V]	$I_c$ [A]	$I_F$ [A]	$T_j$ [°C]	$I_D$ [A]	Min	Typ	Max	
<b>Input Rectifier Diode</b>											
Forward voltage	$V_F$			100	25 125			1,18 1,16	1,9		V
Threshold voltage (for power loss calc. only)	$V_{to}$			100	25 125			0,88 0,75			V
Slope resistance (for power loss calc. only)	$r_t$			100	25 125			0,003 0,004			Ω
Reverse current	$I_r$		1500		25 125				0,05 1,1		mA
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,52			K/W
<b>Inverter Switch</b>											
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$		0,0034	25			5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CESat}$		15	100	25 150				1,9 2,34	2,5	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	1200		25			0,03		mA
Gate-emitter leakage current	$I_{GES}$		20	0		25			700		nA
Integrated Gate resistor	$R_{gint}$							2			Ω
Turn-on delay time	$t_{d(on)}$				25 150			126 130			
Rise time	$t_r$				25 150			17 22			
Turn-off delay time	$t_{d(off)}$	$R_{goff} = 4 \Omega$ $R_{gon} = 4 \Omega$	±15	600	100	25 150		242 316			ns
Fall time	$t_f$					25 150		63 115			
Turn-on energy loss	$E_{on}$					25 150		4,07 6,64			mWs
Turn-off energy loss	$E_{off}$					25 150		5,22 8,71			
Input capacitance	$C_{ies}$							5540			
Output capacitance	$C_{oss}$	$f = 1 \text{ MHz}$	0	25		25		410			pF
Reverse transfer capacitance	$C_{rss}$							320			
Gate charge	$Q_G$		±15			25		580			nC
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,35			K/W
<b>Inverter Diode</b>											
Diode forward voltage	$V_F$			100	25 150			1,83 1,86	2,4		V
Peak reverse recovery current	$I_{RRM}$				25 150			167 191			A
Reverse recovery time	$t_{rr}$				25 150			134 293			ns
Reverse recovered charge	$Q_{rr}$	$R_{gon} = 4 \Omega$	±15	600	100	25 150		9,39 19,67			μC
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					25 150		7887 3332			A/μs
Reverse recovered energy	$E_{rec}$					25 150		3,82 8,55			mWs
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,62			K/W



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V23990-P760-A-PM

V23990-P760-AY-PM

datasheet

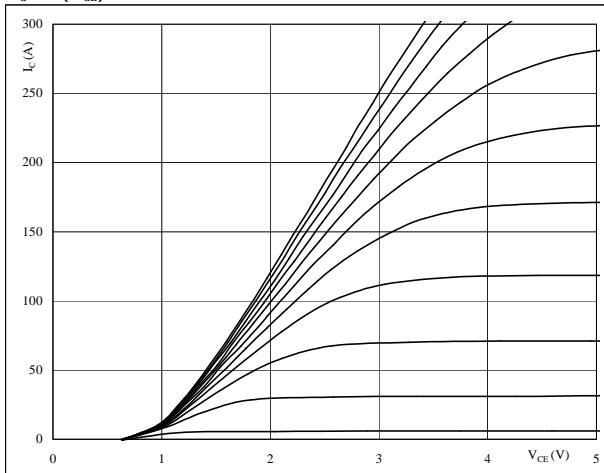
## Characteristic Values

Parameter	Symbol	Conditions						Value			Unit
		$V_{GE}$ [V]	$V_r$ [V]	$I_c$ [A]	$I_F$ [A]	$T_j$ [ $^{\circ}$ C]	$I_D$ [A]	Min	Typ	Max	
<b>Brake Switch</b>											
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0017	25		5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CESat}$		15		50	25 150			1,84 2,27	2,3	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	1200		25				0,25	mA
Gate-emitter leakage current	$I_{GES}$		20	0		25				700	nA
Integrated Gate resistor	$R_{gint}$							4			$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff} = 8 \Omega$ $R_{gon} = 8 \Omega$	$\pm 15$	600	50	25 150		117 121			ns
Rise time	$t_r$					25 150		18 24			
Turn-off delay time	$t_{d(off)}$					25 150		249 316			
Fall time	$t_f$					25 150		88 125			
Turn-on energy loss	$E_{on}$					25 150		2,39 3,43			mWs
Turn-off energy loss	$E_{off}$					25 150		2,96 4,8			
Input capacitance	$C_{ies}$							2770			
Output capacitance	$C_{oss}$	$f = 1 \text{ MHz}$	0	25	25			205			pF
Reverse transfer capacitance	$C_{rss}$							160			
Gate charge	$Q_G$							290			
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,55			K/W
<b>Brake Inverse Diode</b>											
Diode forward voltage	$V_F$				10	25 150		1,1 1,8	1,84 1,8	2,1	V
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)							1,68		K/W
<b>Brake Diode</b>											
Diode forward voltage	$V_F$				25	25 150			1,87 1,83	2,2	V
Reverse leakage current	$I_r$	$R_{gon} = 8 \Omega$	$\pm 15$	600	50	25 150				10	$\mu\text{A}$
Peak reverse recovery current	$I_{RRM}$					25 150			54,29 78,18		A
Reverse recovery time	$t_{rr}$					25 150			158,7 295,4		ns
Reverse recovered charge	$Q_{rr}$					25 150			3,21 6,6		$\mu\text{C}$
Peak rate of fall of recovery current	$(di_{rd}/dt)_{max}$					25 150			4114 3412		$\text{A}/\mu\text{s}$
Reverse recovery energy	$E_{rec}$					25 150			3,21 6,6		mWs
Thermal resistance junction to heatsink	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)							1,09		K/W
<b>Thermistor</b>											
Rated resistance	$R_{25}$					25		20,9	22	23,1	$\text{k}\Omega$
Deviation of $R_{100}$	$D_{R/R}$	$R_{100}=1486 \Omega$				100			2,9		%
Power dissipation	$P$					25			210		mW
Power dissipation constant	$B_{(25/100)}$	Tol. ±3%				25			2		K

## Output Inverter

**figure 1.**
**IGBT**
**Typical output characteristics**

$$I_C = f(V_{CE})$$


**At**

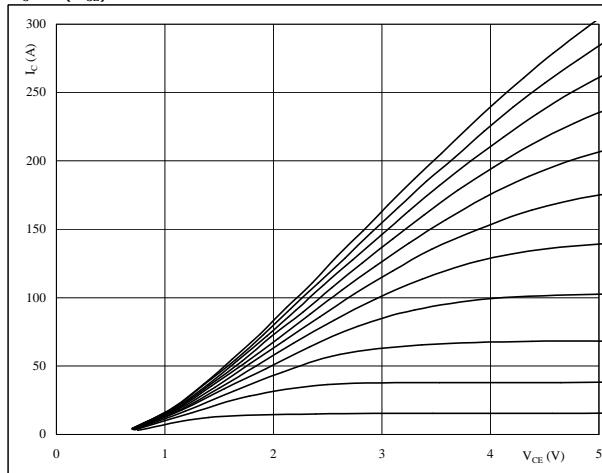
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

**figure 2.**
**IGBT**
**Typical output characteristics**

$$I_C = f(V_{CE})$$


**At**

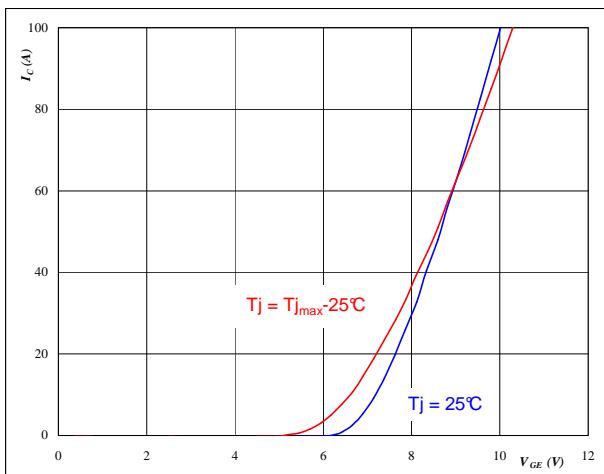
$$t_p = 250 \mu\text{s}$$

$$T_j = 150^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

**figure 3.**
**IGBT**
**Typical transfer characteristics**

$$I_c = f(V_{GE})$$

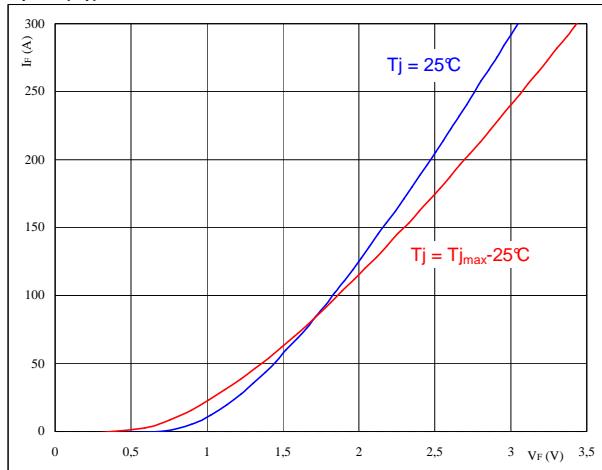

**At**

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

**figure 4.**
**FWD**
**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

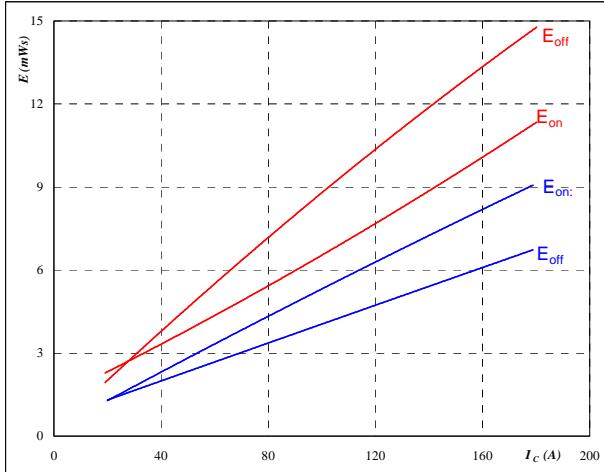

**At**

$$t_p = 250 \mu\text{s}$$

## Output Inverter

**figure 5.**
**IGBT**
**Typical switching energy losses  
as a function of collector current**

$$E = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

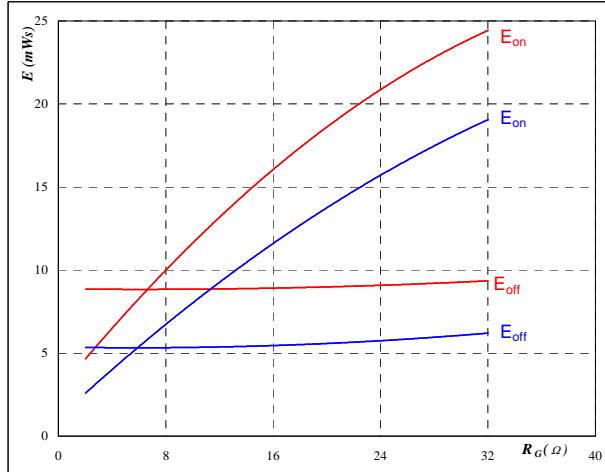
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

$$R_{goff} = 4 \quad \Omega$$

**figure 6.**
**IGBT**
**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

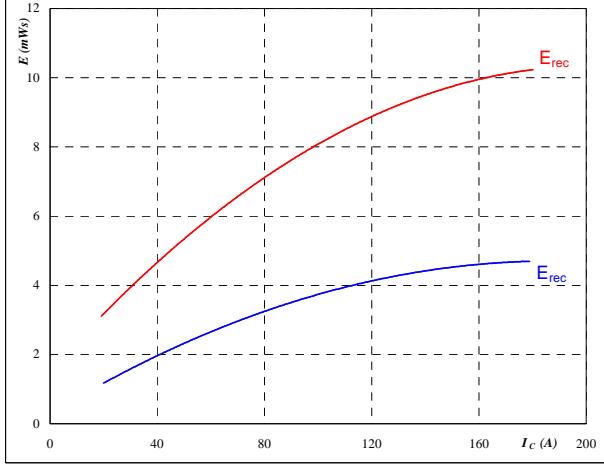
$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_c = 100 \quad \text{A}$$

**figure 7.**
**IGBT**
**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

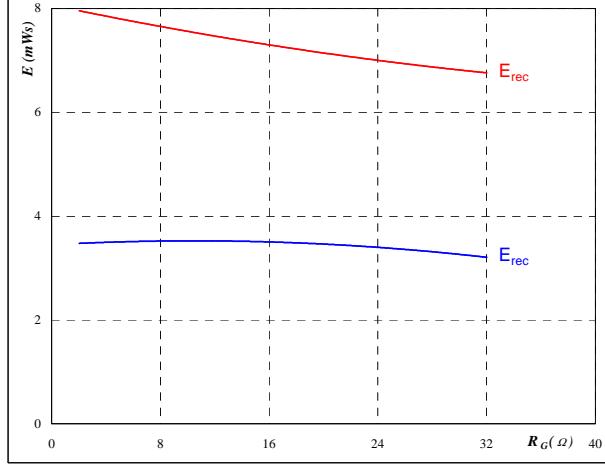
$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**figure 8.**
**IGBT**
**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25/150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

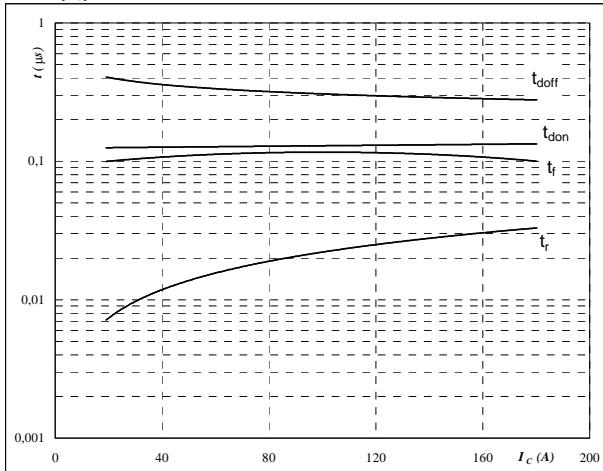
$$I_c = 100 \quad \text{A}$$

## Output Inverter

**figure 9.**

**Typical switching times as a function of collector current**

$$t = f(I_c)$$



With an inductive load at

$$T_j = 150 \text{ } ^\circ\text{C}$$

$$V_{CE} = 600 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

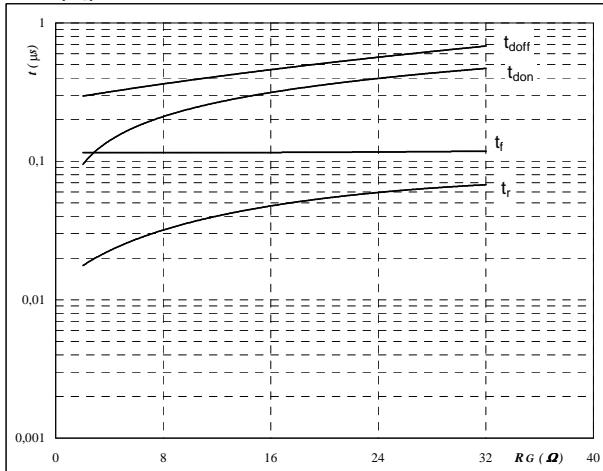
$$R_{gon} = 4 \text{ } \Omega$$

$$R_{goff} = 4 \text{ } \Omega$$

**IGBT****figure 10.**

**Typical switching times as a function of gate resistor**

$$t = f(R_G)$$



With an inductive load at

$$T_j = 150 \text{ } ^\circ\text{C}$$

$$V_{CE} = 600 \text{ V}$$

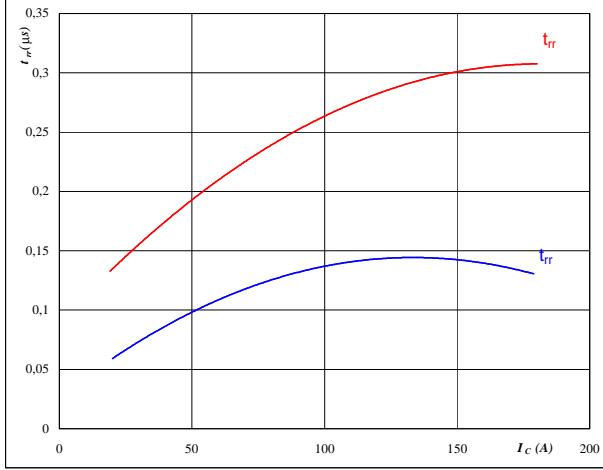
$$V_{GE} = \pm 15 \text{ V}$$

$$I_c = 100 \text{ A}$$

**IGBT****figure 11.****FWD**

**Typical reverse recovery time as a function of collector current**

$$t_{rr} = f(I_c)$$



**At**

$$T_j = 25/150 \text{ } ^\circ\text{C}$$

$$V_{CE} = 600 \text{ V}$$

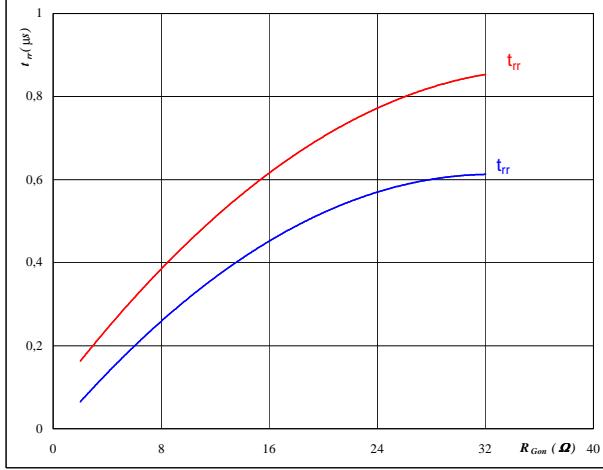
$$V_{GE} = \pm 15 \text{ V}$$

$$R_{gon} = 4 \text{ } \Omega$$

**figure 12.****FWD**

**Typical reverse recovery time as a function of IGBT turn on gate resistor**

$$t_{rr} = f(R_{gon})$$



**At**

$$T_j = 25/150 \text{ } ^\circ\text{C}$$

$$V_R = 600 \text{ V}$$

$$I_F = 100 \text{ A}$$

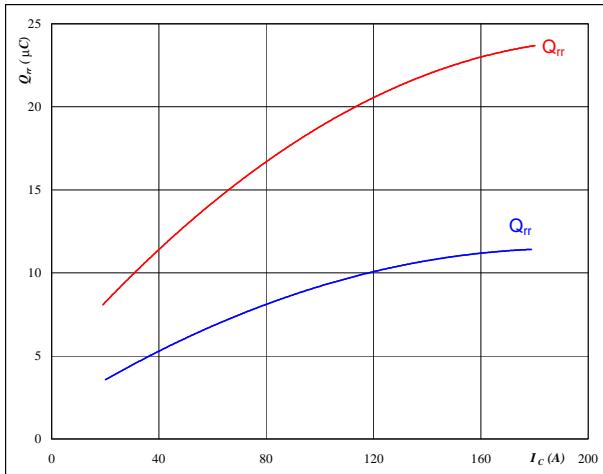
$$V_{GE} = \pm 15 \text{ V}$$

## Output Inverter

**figure 13.****FWD**

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_c)$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad {}^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

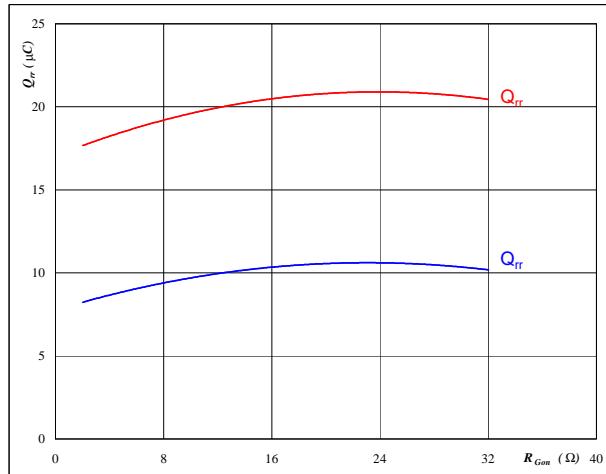
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**figure 14.****FWD**

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad {}^\circ\text{C}$$

$$V_R = 600 \quad \text{V}$$

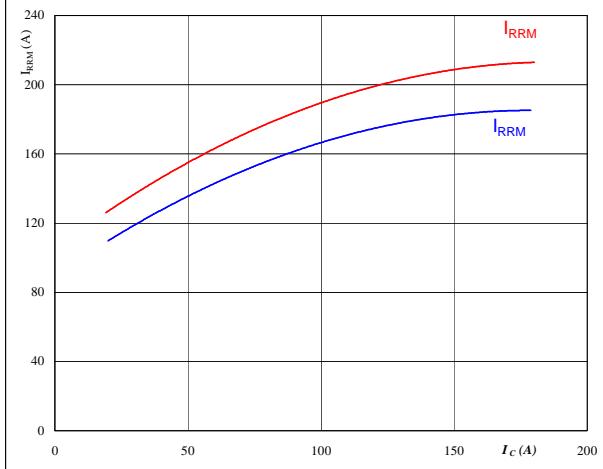
$$I_F = 100 \quad \text{A}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

**figure 15.****FWD**

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_c)$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad {}^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

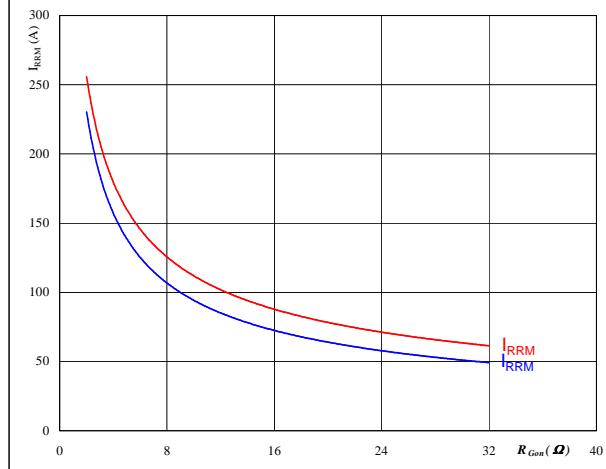
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**figure 16.****FWD**

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

**At**

$$T_j = \textcolor{blue}{25/150} \quad {}^\circ\text{C}$$

$$V_R = 600 \quad \text{V}$$

$$I_F = 100 \quad \text{A}$$

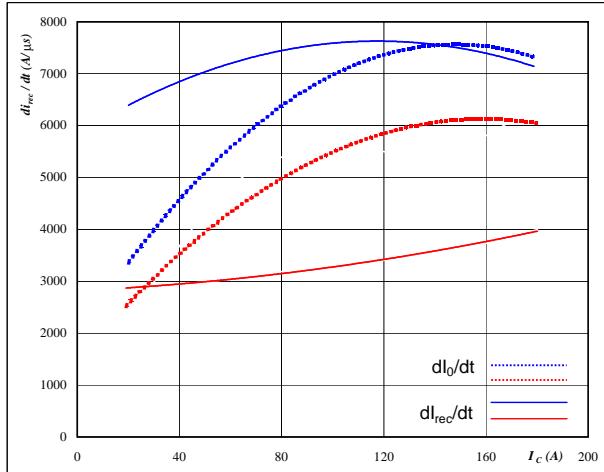
$$V_{GE} = \pm 15 \quad \text{V}$$

## Output Inverter

**figure 17.****FWD**

Typical rate of fall of forward  
and reverse recovery current as a  
function of collector current

$$dI_0/dt, dI_{rec}/dt = f(I_c)$$

**At**

$$T_j = 25/150 \quad ^\circ C$$

$$V_{CE} = 600 \quad V$$

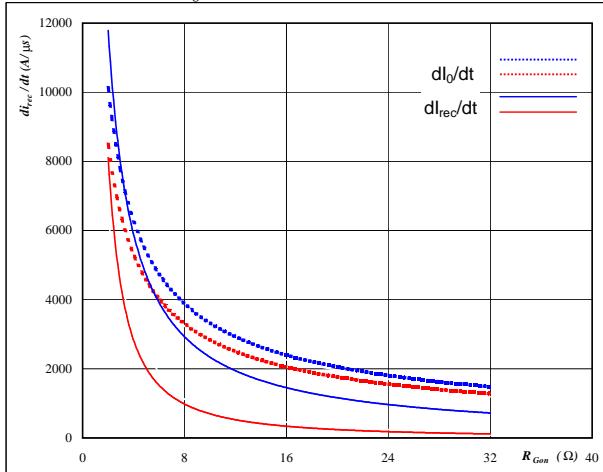
$$V_{GE} = \pm 15 \quad V$$

$$R_{gon} = 4 \quad \Omega$$

**figure 18.****FWD**

Typical rate of fall of forward  
and reverse recovery current as a  
function of IGBT turn on gate resistor

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

**At**

$$T_j = 25/150 \quad ^\circ C$$

$$V_R = 600 \quad V$$

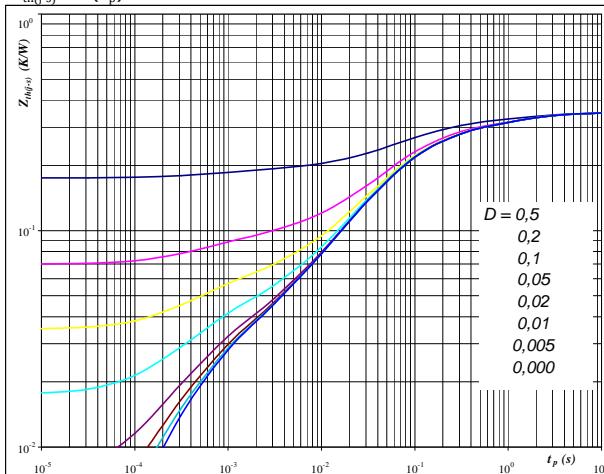
$$I_F = 100 \quad A$$

$$V_{GE} = \pm 15 \quad V$$

**figure 19.**

IGBT transient thermal impedance  
as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 0.35 \quad K/W$$

Single device heated

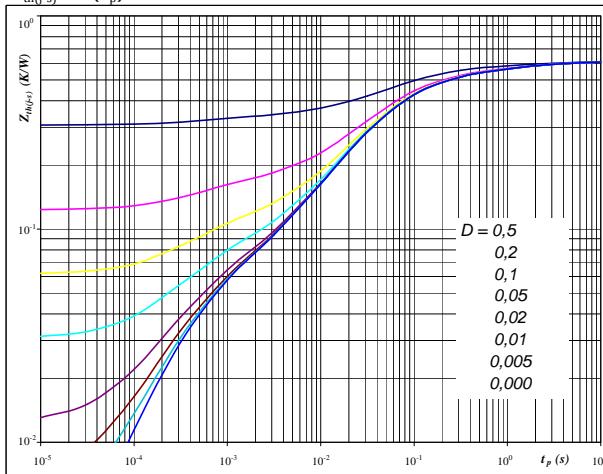
IGBT thermal model values

R (K/W)	Tau (s)
6,03E-02	1,65E+00
7,55E-02	2,28E-01
1,42E-01	5,83E-02
4,00E-02	1,39E-02
1,37E-02	1,77E-03
1,79E-02	3,82E-04

**figure 20.**

FWD transient thermal impedance  
as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 0.62 \quad K/W$$

Single device heated

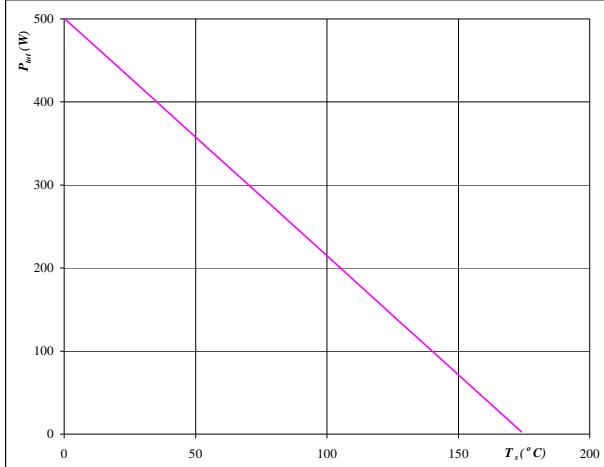
FWD thermal model values

R (K/W)	Tau (s)
2,75E-02	6,85E+00
5,51E-02	1,37E+00
8,48E-02	2,76E-01
2,34E-01	6,50E-02
1,48E-01	1,93E-02
2,67E-02	2,38E-03
3,98E-02	3,81E-04

## Output Inverter

**figure 21.**
**IGBT**
**Power dissipation as a  
function of heatsink temperature**

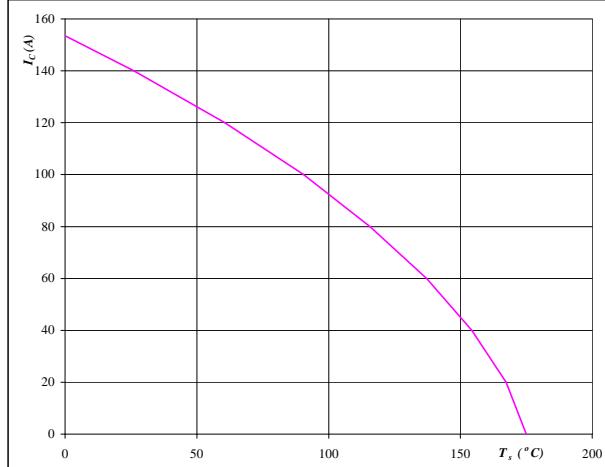
$$P_{\text{tot}} = f(T_s)$$


**At**

$$T_j = 175 \quad ^\circ\text{C}$$

**figure 22.**
**IGBT**
**Collector current as a  
function of heatsink temperature**

$$I_C = f(T_s)$$

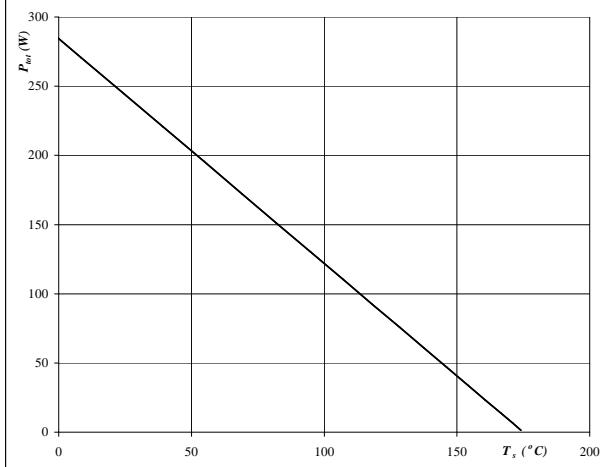

**At**

$$T_j = 175 \quad ^\circ\text{C}$$

$$V_{GE} = 15 \quad \text{V}$$

**figure 23.**
**FWD**
**Power dissipation as a  
function of heatsink temperature**

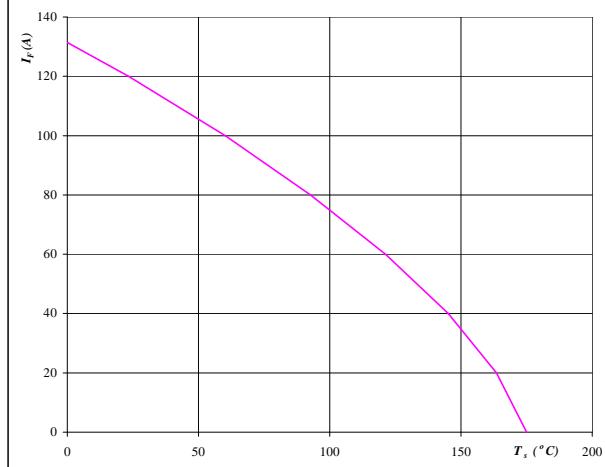
$$P_{\text{tot}} = f(T_s)$$


**At**

$$T_j = 175 \quad ^\circ\text{C}$$

**figure 24.**
**FWD**
**Forward current as a  
function of heatsink temperature**

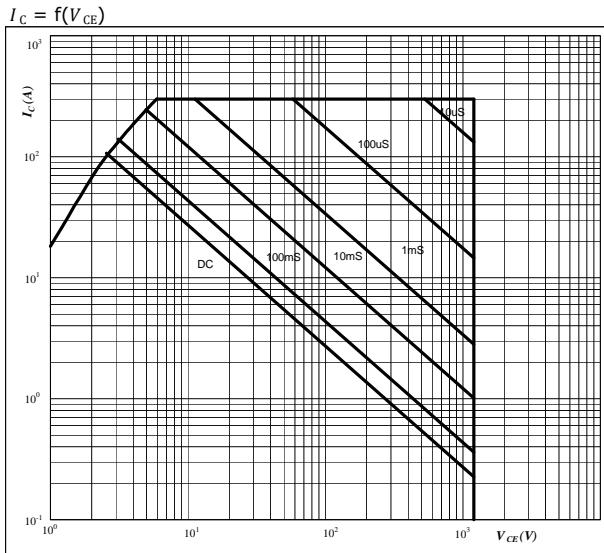
$$I_F = f(T_s)$$


**At**

$$T_j = 175 \quad ^\circ\text{C}$$

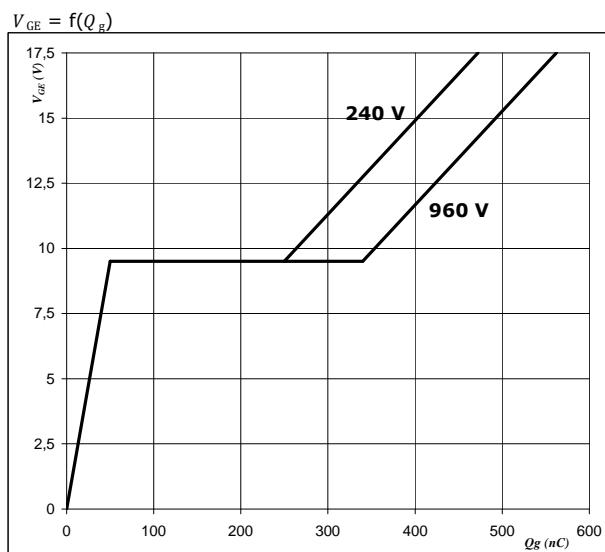
## Output Inverter

**figure 25.**  
**Safe operating area as a function  
of collector-emitter voltage**



IGBT

**figure 26.**  
**Gate voltage vs Gate charge**



IGBT

**At**

$D$  = single pulse  
 $T_s$  = 80 °C  
 $V_{GE}$  = ±15 V  
 $T_j$  =  $T_{jmax}$

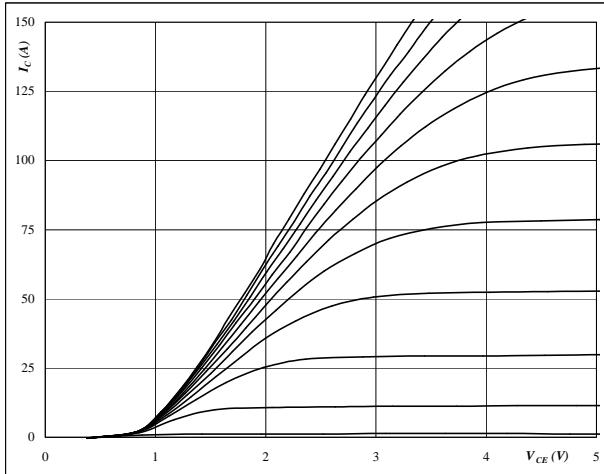
**At**

$I_C$  = 100 A

# Brake

**figure 1.**
**Typical output characteristics**

$$I_C = f(V_{CE})$$


**At**

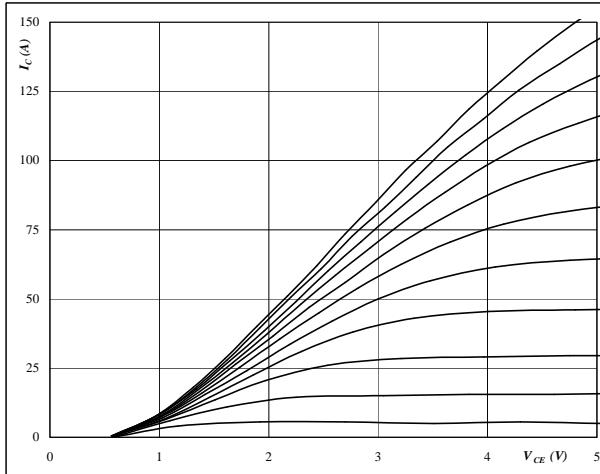
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

**IGBT**
**figure 2.**
**Typical output characteristics**

$$I_C = f(V_{CE})$$


**At**

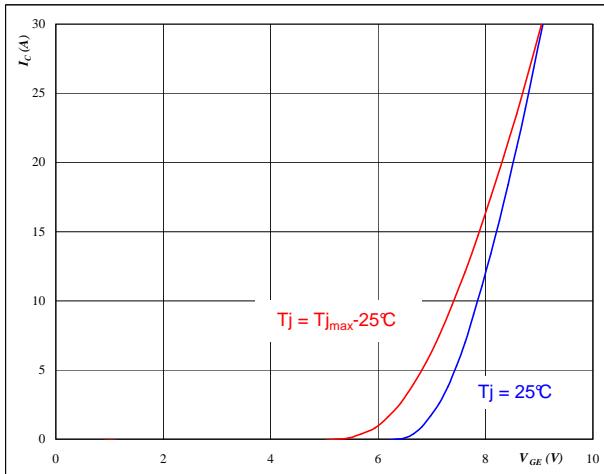
$$t_p = 250 \mu\text{s}$$

$$T_j = 150^\circ\text{C}$$

VGE from 7 V to 17 V in steps of 1 V

**IGBT**
**figure 3.**
**Typical transfer characteristics**

$$I_C = f(V_{GE})$$

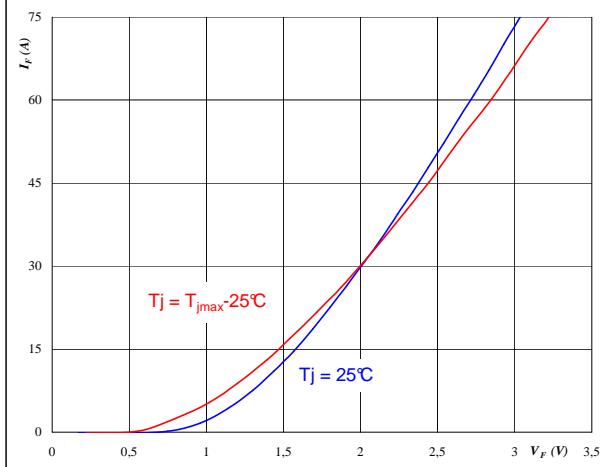

**At**

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

**IGBT**
**figure 4.**
**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$


**At**

$$t_p = 250 \mu\text{s}$$

**FWD**

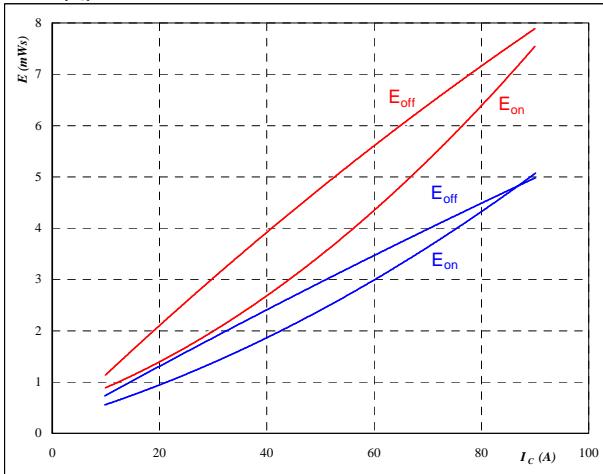
# Brake

**figure 5.**

IGBT

**Typical switching energy losses  
as a function of collector current**

$$E = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 8 \quad \Omega$$

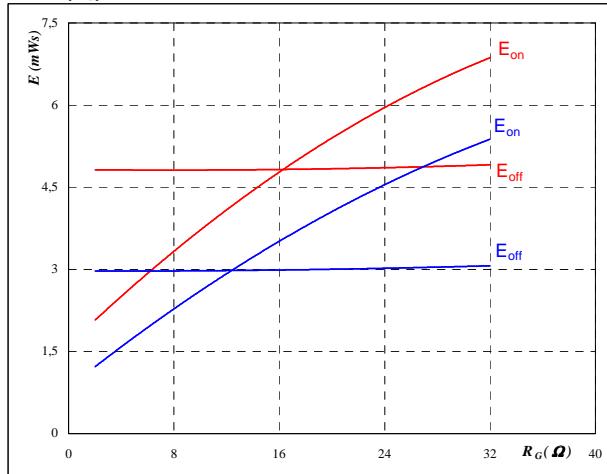
$$R_{goff} = 8 \quad \Omega$$

**figure 6.**

IGBT

**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

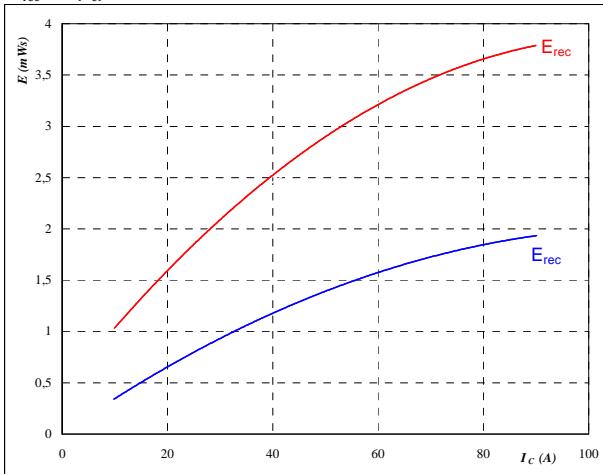
$$I_c = 50 \quad \text{A}$$

**figure 7.**

IGBT

**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_c)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

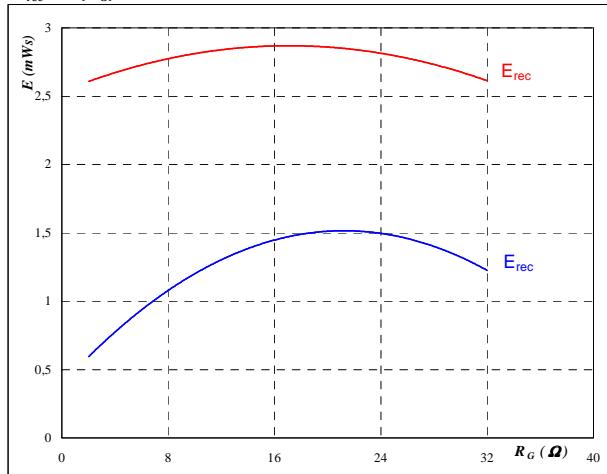
$$R_{gon} = 8 \quad \Omega$$

**figure 8.**

IGBT

**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$$T_j = \textcolor{blue}{25}/\textcolor{red}{150} \quad ^\circ\text{C}$$

$$V_{CE} = 600 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_c = 50 \quad \text{A}$$

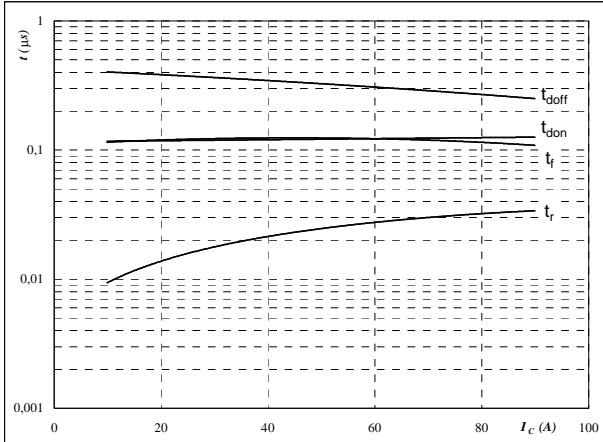
# Brake

**figure 9.**

IGBT

**Typical switching times as a function of collector current**

$$t = f(I_C)$$



With an inductive load at

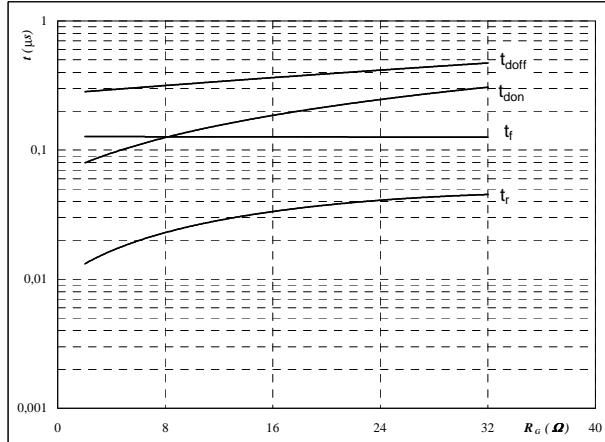
$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$R_{gon} =$	8	Ω
$R_{goff} =$	8	Ω

**figure 10.**

IGBT

**Typical switching times as a function of gate resistor**

$$t = f(R_G)$$



With an inductive load at

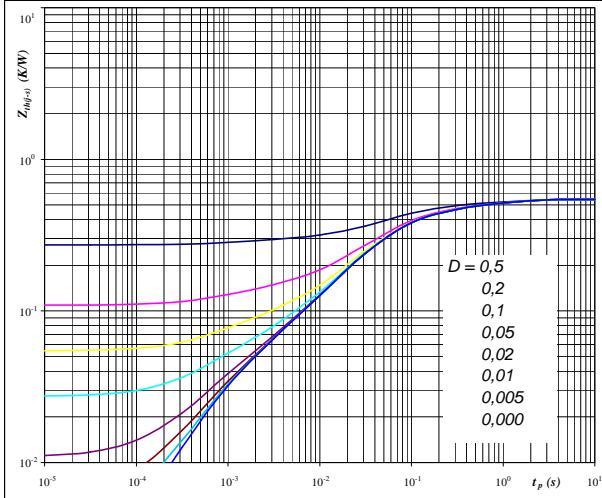
$T_j =$	150	°C
$V_{CE} =$	600	V
$V_{GE} =$	±15	V
$I_C =$	50	A

**figure 11.**

IGBT

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$



**At**

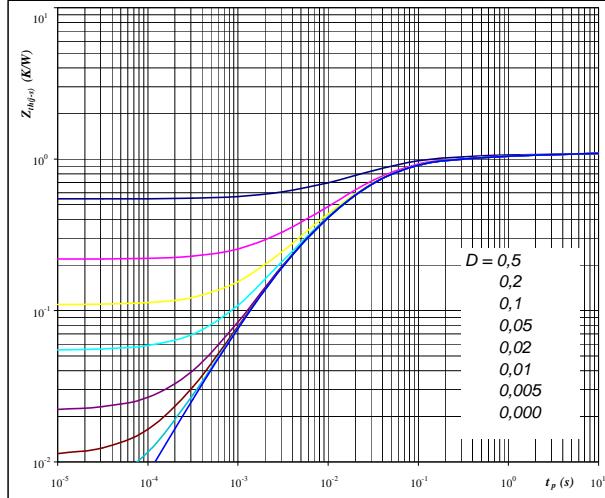
$$\begin{aligned} D &= t_p / T \\ R_{th(j-s)} &= 0.54 \quad \text{K/W} \end{aligned}$$

**figure 12.**

FWD

**FWD transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$



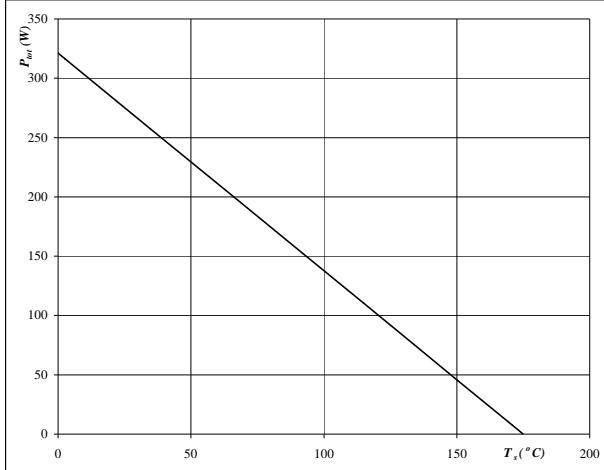
**At**

$$\begin{aligned} D &= t_p / T \\ R_{th(j-s)} &= 1.09 \quad \text{K/W} \end{aligned}$$

# Brake

**figure 13.**
**IGBT**
**Power dissipation as a  
function of heatsink temperature**

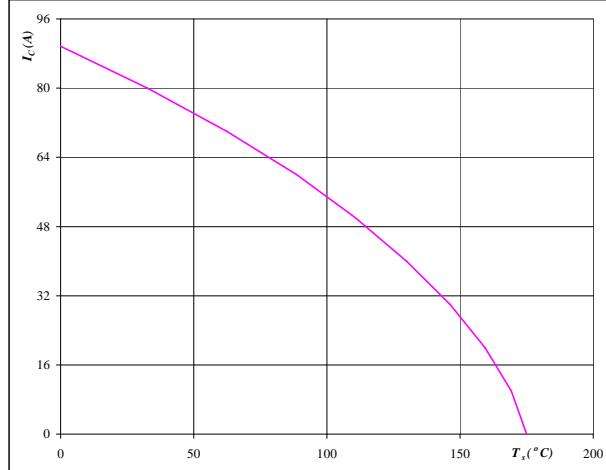
$$P_{\text{tot}} = f(T_s)$$


**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**figure 14.**
**IGBT**
**Collector current as a  
function of heatsink temperature**

$$I_C = f(T_s)$$

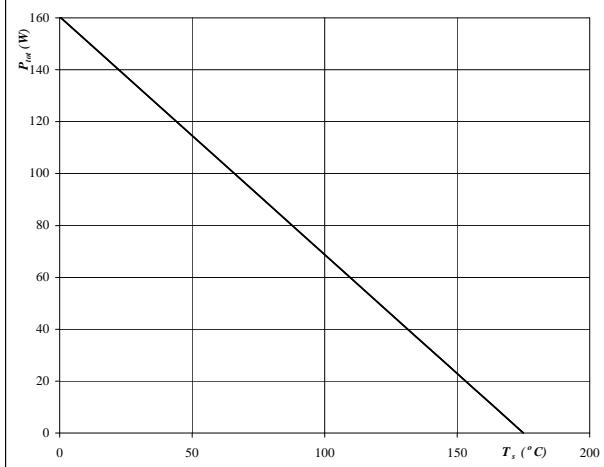

**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

$$V_{GE} = 15 \text{ V}$$

**figure 15.**
**FWD**
**Power dissipation as a  
function of heatsink temperature**

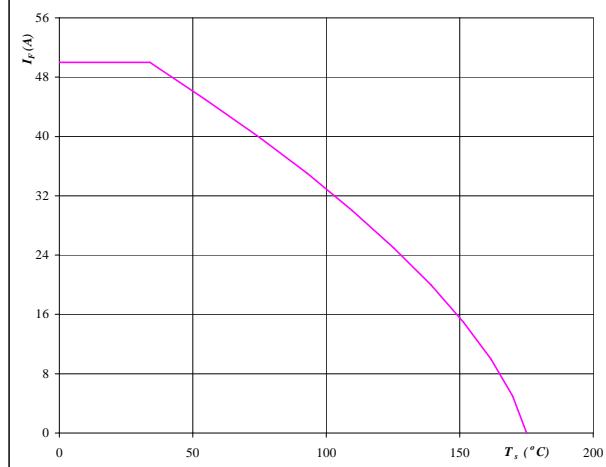
$$P_{\text{tot}} = f(T_s)$$


**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**figure 16.**
**FWD**
**Forward current as a  
function of heatsink temperature**

$$I_F = f(T_s)$$


**At**

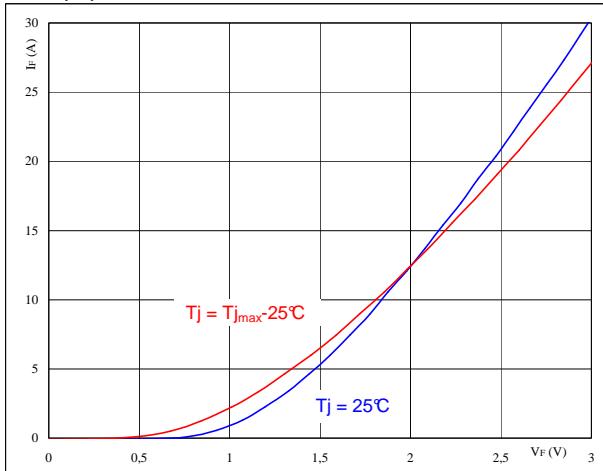
$$T_j = 175 \text{ } ^\circ\text{C}$$

## Brake Inverse Diode

**figure 1.**
**Brake Inverse Diode**

**Typical diode forward current as a function of forward voltage**

$$I_F = f(V_F)$$

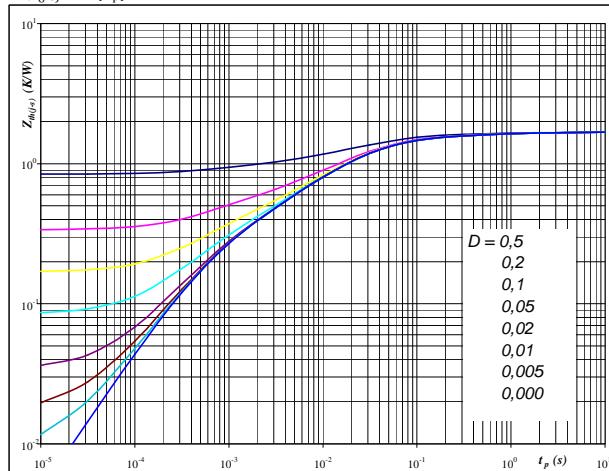

**At**

$$t_p = 250 \mu\text{s}$$

**figure 2.**
**Brake Inverse Diode**

**Diode transient thermal impedance as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$


**At**

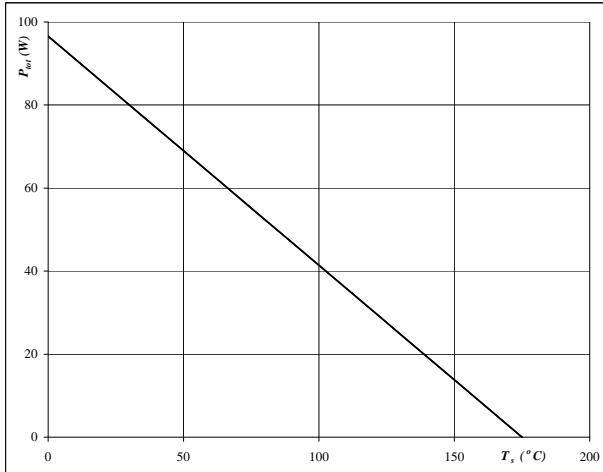
$$D = t_p / T$$

$$R_{th(j-s)} = 1,68 \text{ K/W}$$

**figure 3.**
**Brake Inverse Diode**

**Power dissipation as a function of heatsink temperature**

$$P_{tot} = f(T_s)$$

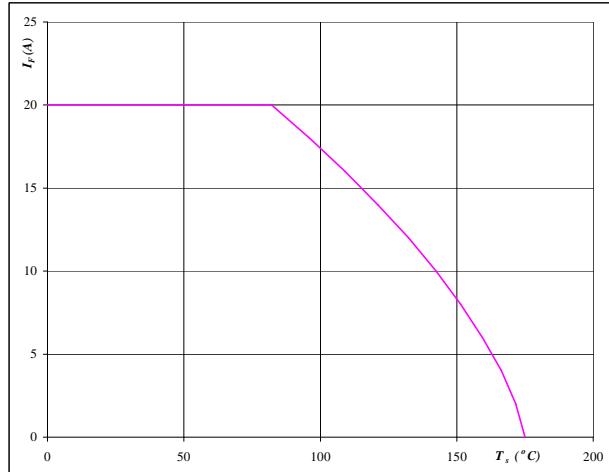

**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

**figure 4.**
**Brake Inverse Diode**

**Forward current as a function of heatsink temperature**

$$I_F = f(T_s)$$

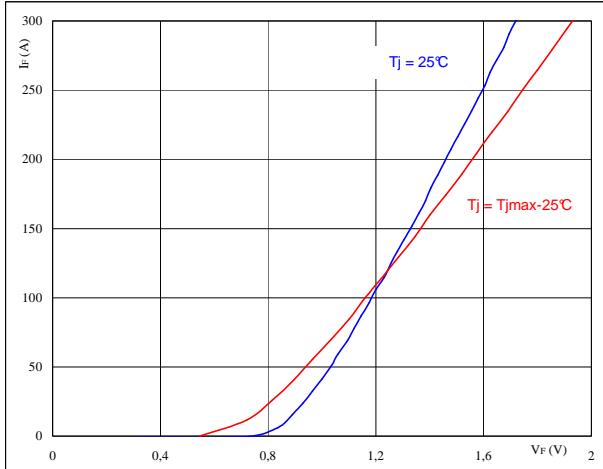

**At**

$$T_j = 175 \text{ } ^\circ\text{C}$$

# Input Rectifier Diode

**figure 1.**
**Rectifier Diode**
**Typical diode forward current as  
a function of forward voltage**

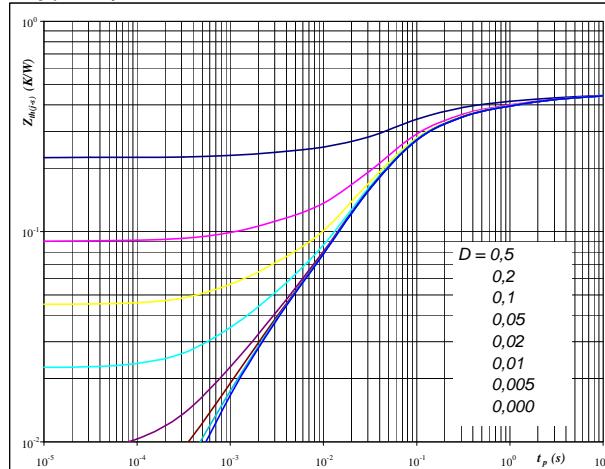
$$I_F = f(V_F)$$


**At**

$$t_p = 250 \mu\text{s}$$

**figure 2.**
**Rectifier Diode**
**Diode transient thermal impedance  
as a function of pulse width**

$$Z_{th(j-s)} = f(t_p)$$

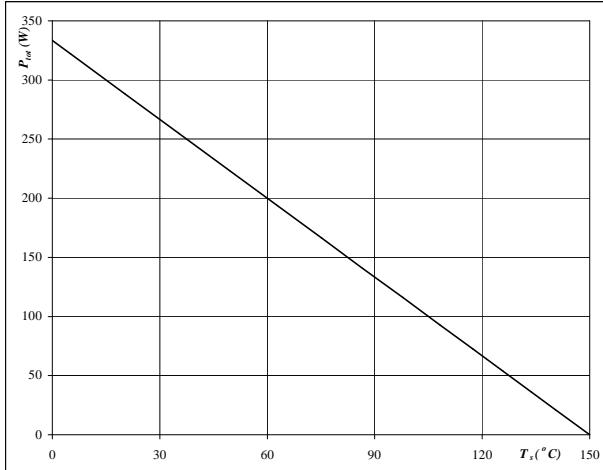

**At**

$$D = t_p / T$$

$$R_{th(j-s)} = 0,45 \text{ K/W}$$

**figure 3.**
**Rectifier Diode**
**Power dissipation as a  
function of heatsink temperature**

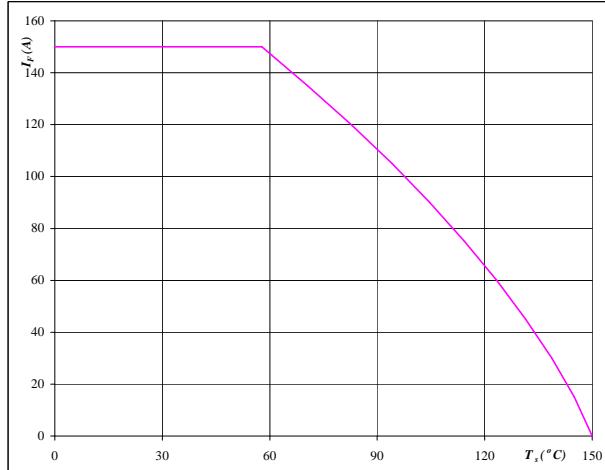
$$P_{tot} = f(T_s)$$


**At**

$$T_j = 150 \text{ °C}$$

**figure 4.**
**Rectifier Diode**
**Forward current as a  
function of heatsink temperature**

$$I_F = f(T_s)$$


**At**

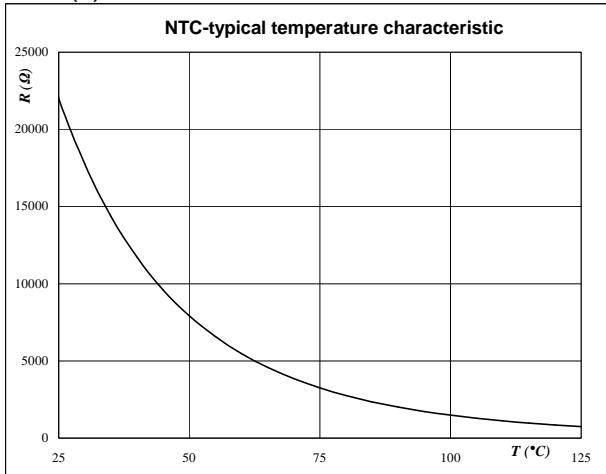
$$T_j = 150 \text{ °C}$$

## Thermistor

**figure 1.** Thermistor

**Typical NTC characteristic  
as a function of temperature**

$$R_T = f(T)$$



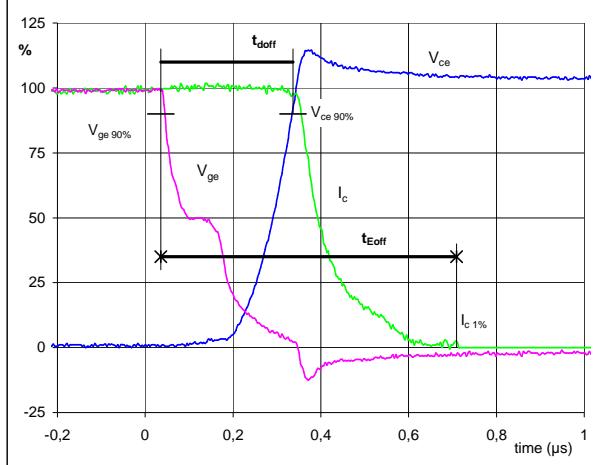
## Switching Definitions Output Inverter

**General conditions**

$T_j$	= 125 °C
$R_{gon}$	= 4 Ω
$R_{goff}$	= 4 Ω

**figure 1.**

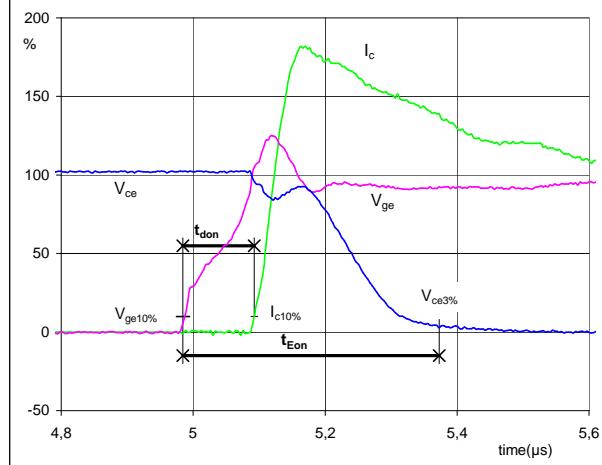
**IGBT**  
**Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$**   
 $(t_{Eoff} = \text{integrating time for } E_{off})$



$V_{GE}(0\%) = -15$  V  
 $V_{GE}(100\%) = 15$  V  
 $V_C(100\%) = 600$  V  
 $I_C(100\%) = 100$  A  
 $t_{doff} = 0,29$  μs  
 $t_{Eoff} = 0,67$  μs

**figure 2.**

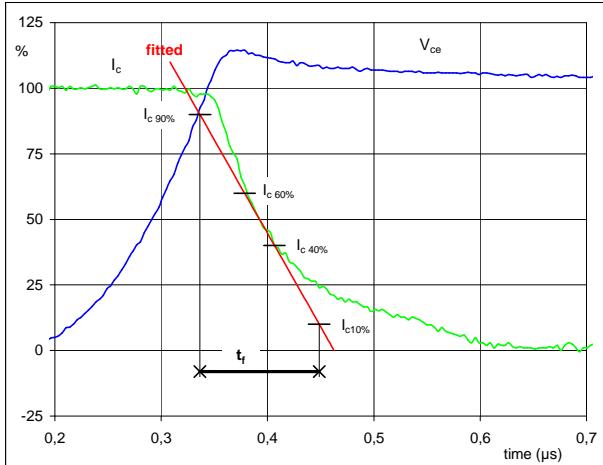
**IGBT**  
**Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$**   
 $(t_{Eon} = \text{integrating time for } E_{on})$



$V_{GE}(0\%) = -15$  V  
 $V_{GE}(100\%) = 15$  V  
 $V_C(100\%) = 600$  V  
 $I_C(100\%) = 100$  A  
 $t_{don} = 0,11$  μs  
 $t_{Eon} = 0,39$  μs

**figure 3.**

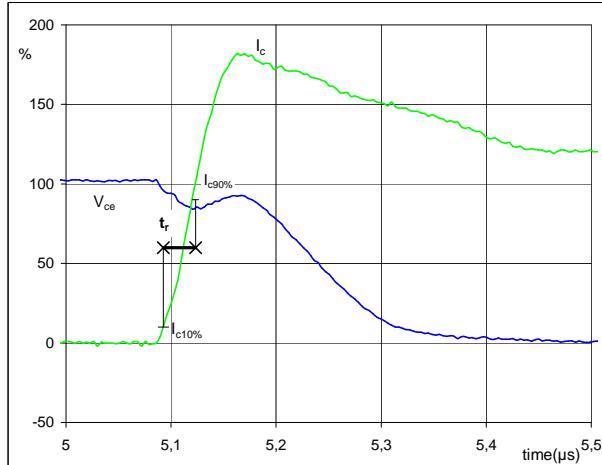
**IGBT**  
**Turn-off Switching Waveforms & definition of  $t_f$**



$V_C(100\%) = 600$  V  
 $I_C(100\%) = 100$  A  
 $t_f = 0,11$  μs

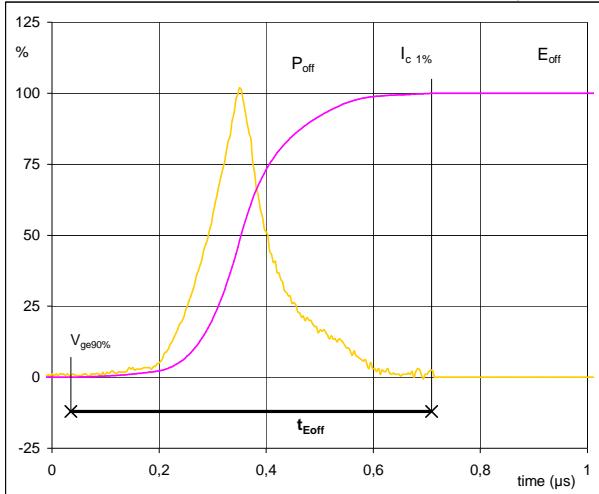
**figure 4.**

**IGBT**  
**Turn-on Switching Waveforms & definition of  $t_r$**

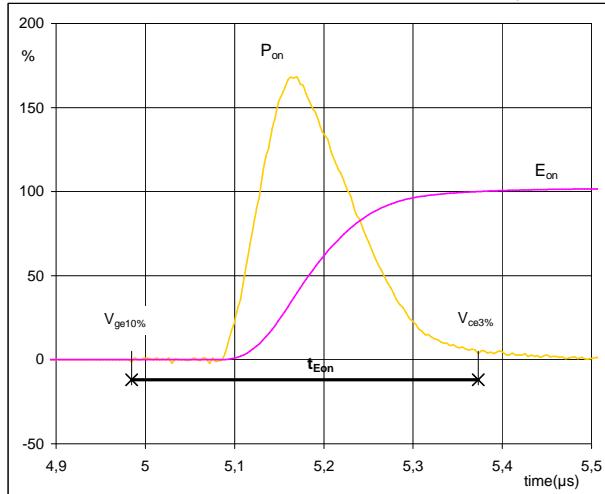
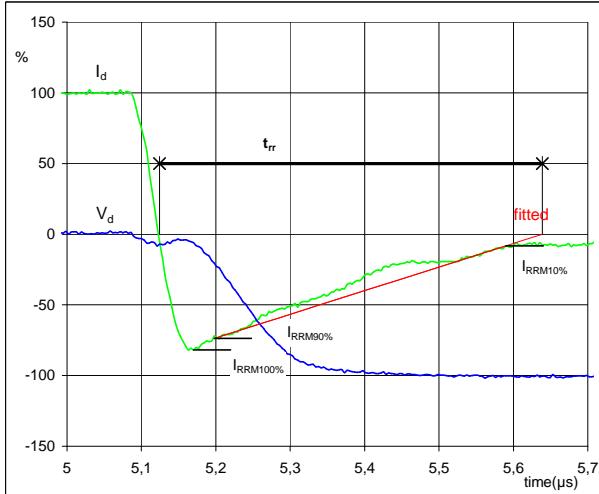


$V_C(100\%) = 600$  V  
 $I_C(100\%) = 100$  A  
 $t_r = 0,03$  μs

## Switching Definitions Output Inverter

**figure 5.****IGBT****Turn-off Switching Waveforms & definition of  $t_{E\text{off}}$** 

$$\begin{aligned} P_{\text{off}} (100\%) &= 59,91 \text{ kW} \\ E_{\text{off}} (100\%) &= 8,87 \text{ mJ} \\ t_{E\text{off}} &= 0,67 \mu\text{s} \end{aligned}$$

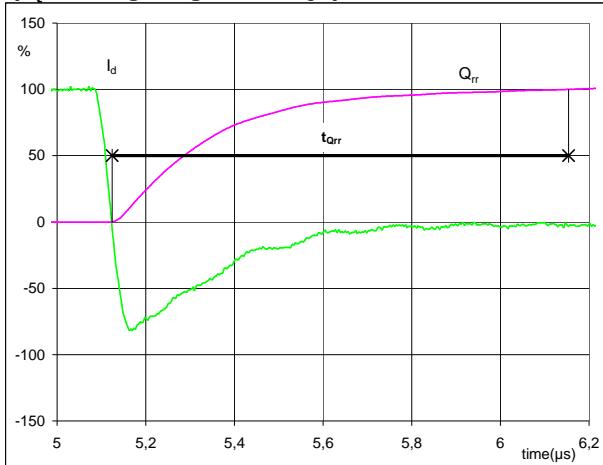
**figure 6.****IGBT****Turn-on Switching Waveforms & definition of  $t_{E\text{on}}$** **figure 7.****FWD****Turn-off Switching Waveforms & definition of  $t_{rr}$** 

$$\begin{aligned} V_d (100\%) &= 600 \text{ V} \\ I_d (100\%) &= 100 \text{ A} \\ I_{\text{RRM}} (100\%) &= -83 \text{ A} \\ t_{rr} &= 0,51 \mu\text{s} \end{aligned}$$

## Switching Definitions Output Inverter

**figure 8.****FWD**

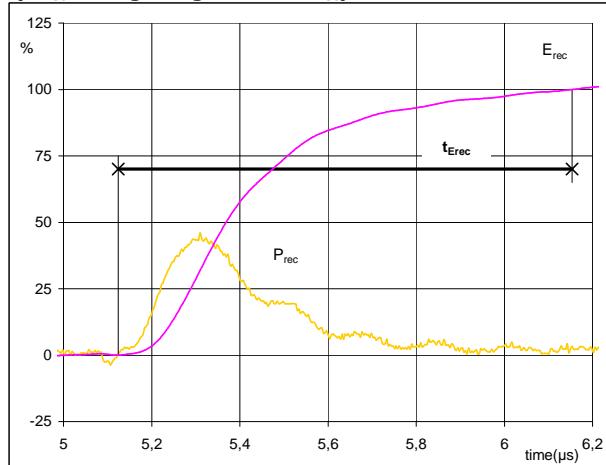
**Turn-on Switching Waveforms & definition of  $t_{Qrr}$**   
 $(t_{Qrr} = \text{integrating time for } Q_{rr})$



$I_d (100\%) = 100 \text{ A}$   
 $Q_{rr} (100\%) = 20,73 \mu\text{C}$   
 $t_{Qint} = 1,03 \mu\text{s}$

**figure 9.****FWD**

**Turn-on Switching Waveforms & definition of  $t_{Erec}$**   
 $(t_{Erec} = \text{integrating time for } E_{rec})$



$P_{rec} (100\%) = 59,91 \text{ kW}$   
 $E_{rec} (100\%) = 7,85 \text{ mJ}$   
 $t_{Erec} = 1,03 \mu\text{s}$



Vincotech

**V23990-P760-A-PM****V23990-P760-AY-PM**

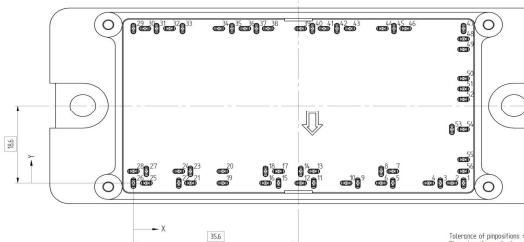
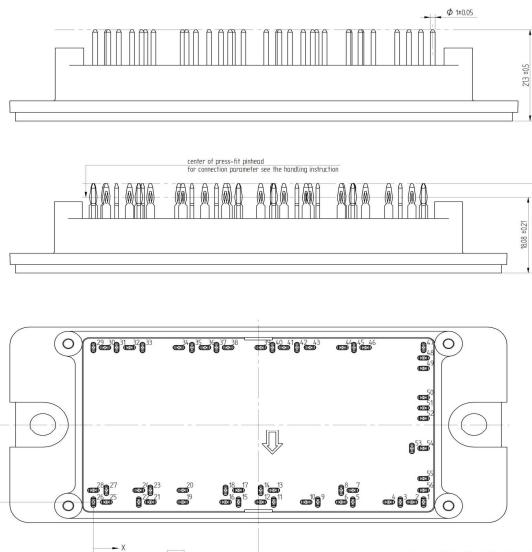
datasheet

**Ordering Code & Marking**

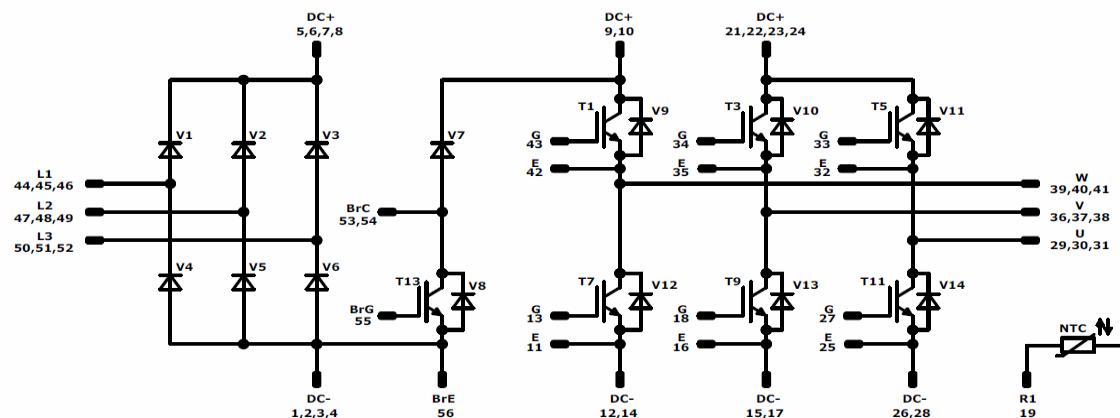
Version		Ordering Code							
without thermal paste with solder pins		V23990-P760-A-PM							
without thermal paste with Press-fit pins		V23990-P760-AY-PM							
with thermal paste with solder pins		V23990-P760-A-/3/-PM							
with thermal paste with Press-fit pins		V23990-P760-AY-/3/-PM							
VIN WWYY NNNNNNNVV UL LLLLLL SSSS		Text  Datamatrix	VIN	Date code	Name&Ver	UL	Lot	Serial	
			VIN	WWYY	NNNNNNVV	UL	LLLLL	SSSS	
			Type&Ver	Lot number	Serial	Date code			
			TTTTTTVV	LLLLL	SSSS	WWYY			

**Outline**

Pin table [mm]				Pin table [mm]			
Pin	Func	X	Y	Pin	Func	X	Y
1	DC-	71,2	0	29	U	0	37,2
2	DC-	68,7	0	30	U	2,5	37,2
3	DC-	66,2	0	31	U	5	37,2
4	DC-	63,7	0	32	E	7,8	37,2
5	DC+	55,95	0	33	G	10,6	37,2
6	DC+	53,45	0	34	G	18,45	37,2
7	DC+	55,95	2,8	35	E	21,25	37,2
8	DC+	53,45	2,8	36	V	24,05	37,2
9	DC+	48,4	0	37	V	26,55	37,2
10	DC+	45,9	0	38	V	29,05	37,2
11	E	38,9	0	39	W	36,1	37,2
12	DC-	36,1	0	40	W	38,6	37,2
13	G	38,9	2,8	41	W	41,1	37,2
14	DC-	36,1	2,8	42	E	43,9	37,2
15	DC-	31,3	0	43	G	46,7	37,2
16	E	28,5	0	44	L1	53,7	37,2
17	DC-	31,3	2,8	45	L1	56,2	37,2
18	G	28,5	2,8	46	L1	58,7	37,2
19	R2	19,3	0	47	L2	71,2	37,2
20	R1	19,3	2,8	48	L2	71,2	34,7
21	DC+	12,3	0	49	L2	71,2	32,2
22	DC+	9,8	0	50	L3	71,2	25,2
23	DC+	12,3	2,8	51	L3	71,2	22,7
24	DC+	9,8	2,8	52	L3	71,2	20,2
25	E	2,8	0	53	BrC	71,2	12,8
26	DC-	0	0	54	BrC	68,7	12,8
27	G	2,8	2,8	55	BrG	71,2	5,6
28	DC-	0	2,8	56	BrE	71,2	2,8



## Pinout



## Identification

ID	Component	Voltage	Current	Function	Comment
T1,T3,T5,T7,T9,T11	IGBT	1200 V	100 A	Inverter Switch	
V9-V14	FWD	1200 V	100 A	Inverter Diode	
V1-V6	Rectifier	1600 V	75 A	Input Rectifier Diode	
T13	IGBT	1200 V	50 A	Brake Switch	
V7	FWD	1200 V	25 A	Brake Diode	
V8	FWD	1200 V	10 A	Brake Inverse Diode	
NTC	NTC			Thermistor	



Vincotech

V23990-P760-A-PM

V23990-P760-AY-PM

datasheet

<b>Packaging instruction</b>			
Standard packaging quantity (SPQ)	36	>SPQ	Standard

<b>Handling instruction</b>			
Handling instructions for <i>flow</i> 2 packages see <a href="http://vincotech.com">vincotech.com</a> website.			

<b>Package data</b>			
Package data for <i>flow</i> 2 packages see <a href="http://vincotech.com">vincotech.com</a> website.			

<b>UL recognition and file number</b>			
This device is certified according to UL 1557 standard, UL file number E192116. For more information see <a href="http://vincotech.com">vincotech.com</a> website.			

<b>Document No.:</b>	<b>Date:</b>	<b>Modification:</b>	<b>Pages</b>
V23990-P760-Ax -D8-14	26 Feb. 2018	R-Tau table corrected	10

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